

MC10H145

16 x 4 Bit Register File (RAM)

The MC10H145 is a 16 x 4 bit register file. The active-low chip select allows easy expansion.

The operating mode of the register file is controlled by the $\overline{WE}$ input. When $\overline{WE}$ is "low" the device is in the write mode, the outputs are "low" and the data present at D_n input is stored at the selected address, when $\overline{WE}$ is "high," the device is in the read mode – the data state at the selected location is present at the Q_n outputs.

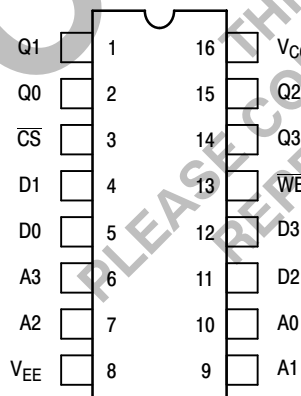
- Address Access Time, 4.5 ns Typical
- Power Dissipation, 700 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

TRUTH TABLE

MODE	INPUT			OUTPUT
	$\overline{CS}$	$\overline{WE}$	D_n	
Write "0"	L	L	L	L
Write "1"	L	L	H	L
Read	L	H	X	Q
Disabled	H	X	X	L

Q-State of Addressed Cell

DIP
PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.

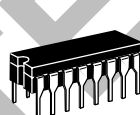
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11 of the Motorola MECL Data Book (DL122/D).



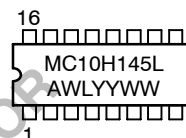
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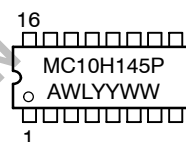
MARKING
DIAGRAMS



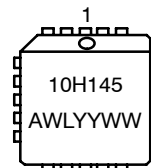
CDIP-16
L SUFFIX
CASE 620



PDIP-16
P SUFFIX
CASE 648



PLCC-20
FN SUFFIX
CASE 775



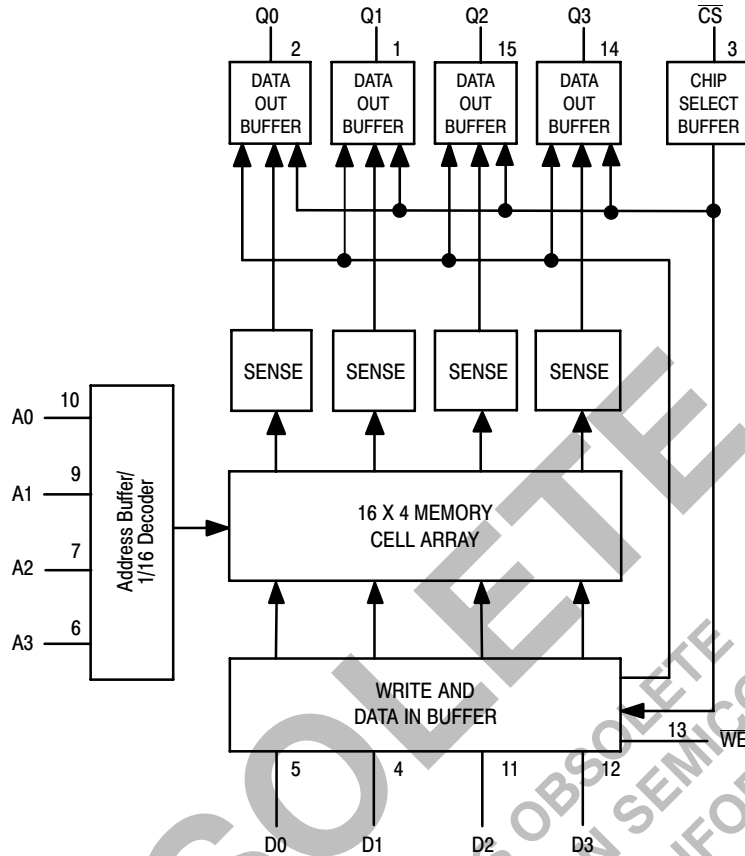
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC10H145L	CDIP-16	25 Units/Rail
MC10H145P	PDIP-16	25 Units/Rail
MC10H145FN	PLCC-20	xx Units/Rail

MC10H145

BLOCK DIAGRAM



MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V_{EE}	Power Supply ($V_{CC} = 0$)	-8.0 to 0	Vdc
V_I	Input Voltage ($V_{CC} = 0$)	0 to V_{EE}	Vdc
I_{out}	Output Current - Continuous - Surge	50 100	mA
T_A	Operating Temperature Range	0 to +75	°C
T_{stg}	Storage Temperature Range - Plastic - Ceramic	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 \text{ V} \pm 5\%$) (See Note)

Symbol	Characteristic	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
I_E	Power Supply Current	-	160	-	163	-	165	mA
I_{inH}	Input Current High	-	375	-	220	-	220	μA
I_{inL}	Input Current Low	0.5	-	0.5	-	0.3	-	μA
V_{OH}	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V_{OL}	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V_{IH}	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V_{IL}	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

1. Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H145

AC PARAMETERS

Symbol	Characteristics	MC10H145 $T_A = 0 \text{ to } +75^\circ\text{C}$, $V_{EE} = -5.2 \text{ Vdc} \pm 5\%$		Unit	Conditions
		Min	Max		
t_{ACS} t_{RCS} t_{AA}	Read Mode Chip Select Access Time Chip Select Recovery Time Address Access Time	0 0 0	4.0 4.0 6.0	ns	Measured from 50% of input to 50% of output. See Note 2.
t_W t_{WSD} t_{WHD} t_{WSA} t_{WHA} t_{WSCS} t_{WHCS} t_{WS} t_{WR}	Write Mode Write Pulse Width Data Setup Time Prior to Write Data Hold Time After Write Address Setup Time Prior to Write Address Hold Time After Write Chip Select Setup Time Prior to Write Chip Select Hold Time After Write Write Disable Time Write Recovery Time	6.0 0 1.5 3.5 1.5 0 1.5 1.0 1.0	— — — — — — — 4.0 4.0	ns	$t_{WSA} = 3.5 \text{ ns}$ Measured at 50% of input to 50% of output. $t_W = 6.0 \text{ ns}$.
t_{CSD} t_{CSW} t_{CSA} t_{CHD} t_{CHW} t_{CHA} t_{CS}	Chip Enable Strobe Mode Data Setup Prior to Chip Select Write Enable Setup Prior to Chip Select Address Setup Prior to Chip Select Data Hold Time After Chip Select Write Enable Hold Time After Chip Select Address Hold Time After Chip Select Chip Select Minimum Pulse Width	0 0 0 1.0 0 2.0 4.0	— — — — — — —	ns	Guaranteed but not tested on standard product. See Figure 1.
t_r , t_f	Rise and Fall Time Address to Output CS to Output	0.6 0.6	2.5 2.5	ns	Measured between 20% and 80% points.
C_{in} C_{out}	Capacitance Input Capacitance Output Capacitance	— —	6.0 8.0	pF	Measured with a pulse technique.

NOTES:

1. Test circuit characteristics: $R_T = 50 \Omega$, MC10H145. $C_L \leq 5.0 \text{ pF}$ (including jig and Stray Capacitance). Delay should be derated 30 ps/pF for capacitive loads up to 50 pF.
2. The maximum Address Access Time is guaranteed to be the worst-case bit in the memory.
3. For proper use of MECL in a system environment, consult MECL System Design Handbook.

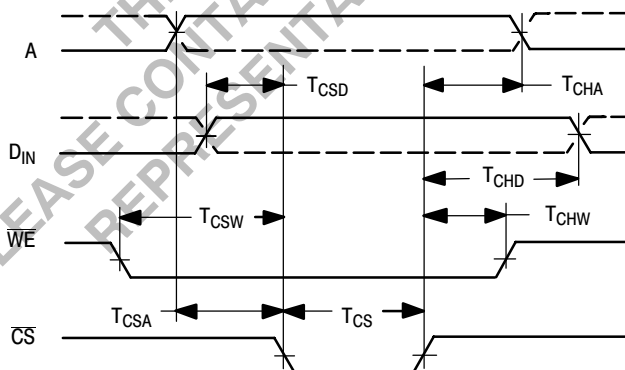
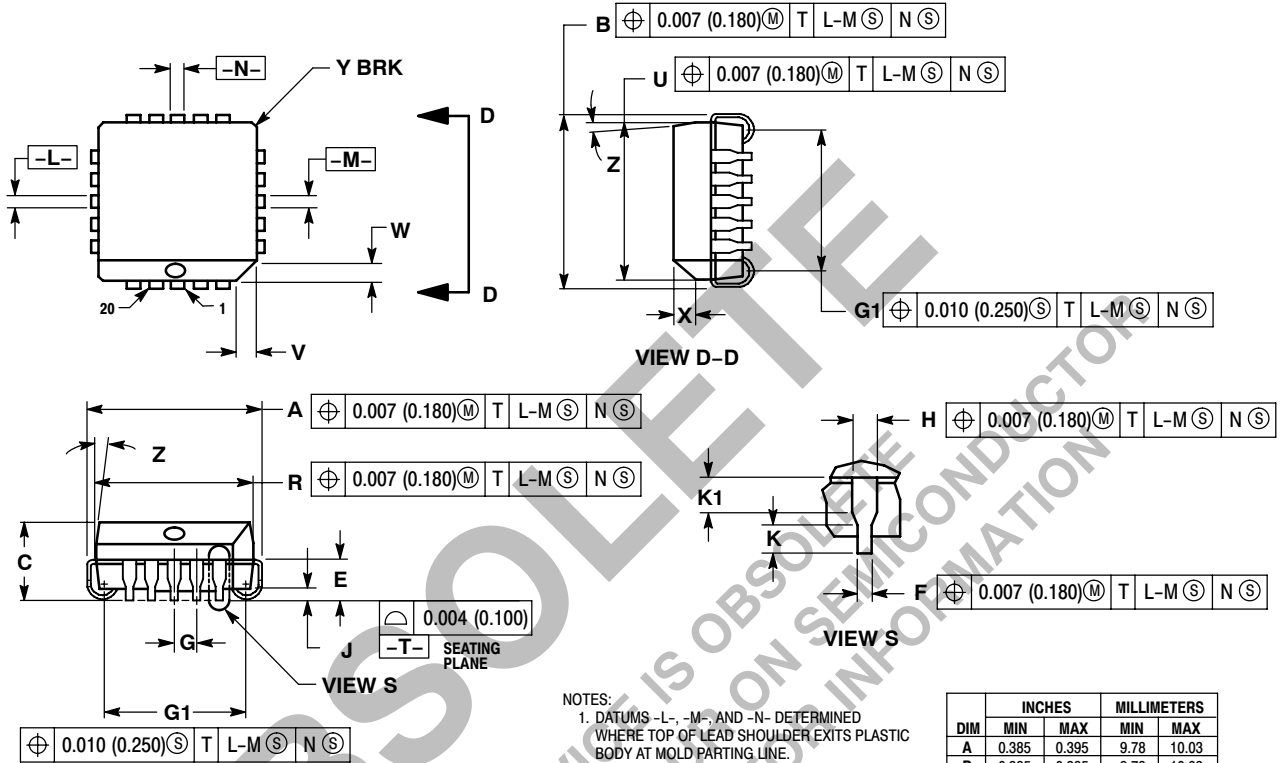


Figure 1. Chip Enable Strobe Mode

MC10H145

PACKAGE DIMENSIONS

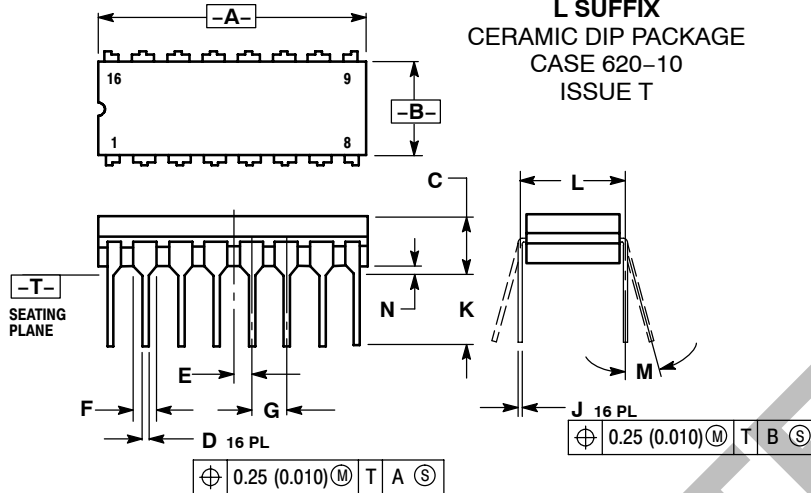
PLCC-20
FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 775-02
ISSUE C



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2°	10°	2°	10°
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

MC10H145

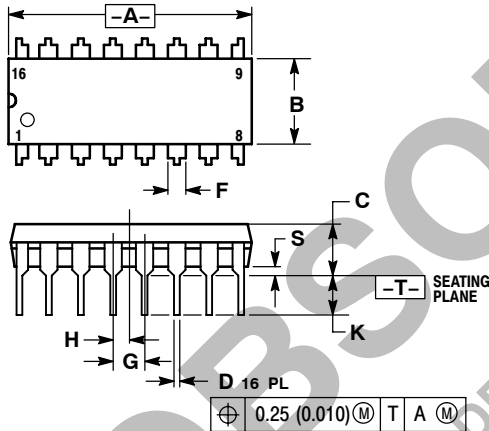
CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE T



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

PDIP-16 P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

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